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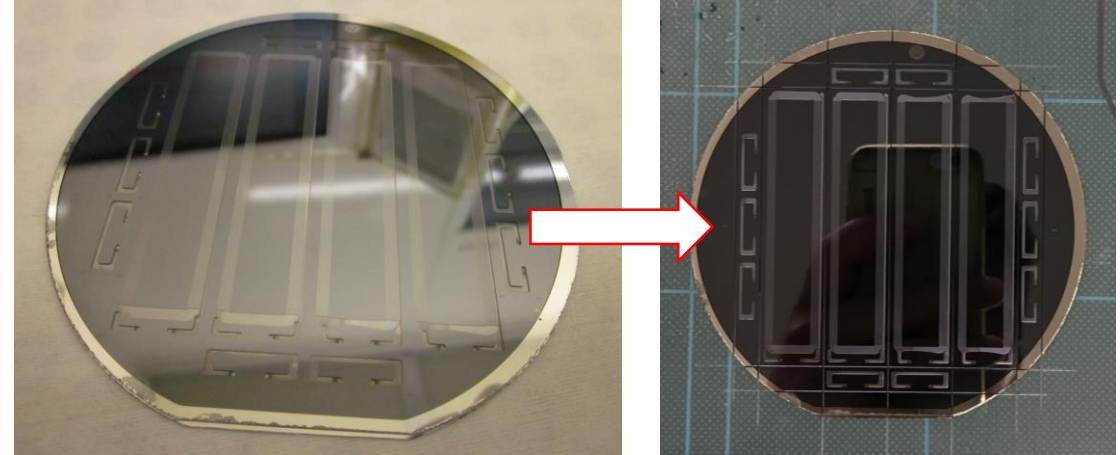
# Micro-weekly

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Massimo Angeletti

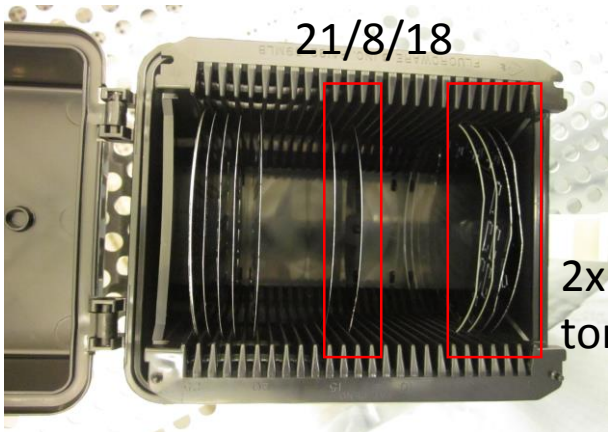
Wednesday 15 August 2018

- First wafer Diced: **ok**
- Remaining 4 wafers **3/4 working day**
- Pressure drop test → **September**



Wafer N.	Litho#1 Step1	Litho#1 Step2	Etching#1 Step3	PR Strip#1 Step4	Litho#2 Step5	Etching#2 Step6	PR Strip#2 Step7	Etching#3 Step8	Etching#4 Step9	Bond. Prep. Step10	Bonding Step11	Litho#5 Step12	Metal dep. Step13	Etching#5 Step14	Metal. Rem Step15	PR Strip#5 Step16	Dicing Step17	
1	6852	08/06/2018	14/06/2018	22/06/2018	22/06/2018	04/07/2018	04/07/2018	04/07/2018	04/07/2018	06/07/2018	10/07/2018	10/07/2018	02/08/2018	09/08/2018	09/08/2018	09/08/2018	13/08/2018	13/08/2018
2	6853	08/06/2018	22/06/2018	22/06/2018	22/06/2018	17/07/2018	17/07/2018	19/07/2018	19/07/2018	07/08/2018	15/08/2018	16/08/2018	/	21/08/2018	21/08/2018	21/08/2018	/	/
3	6854	08/06/2018	22/06/2018	22/06/2018	22/06/2018	10/07/2018	17/07/2018	17/07/2018	17/07/2018	07/08/2018	15/08/2018	16/08/2018	/	21/08/2018	21/08/2018	21/08/2018	/	/
4	6855	08/06/2018	26/07/2018	07/08/2018	07/08/2018	09/08/2018	09/08/2018	14/08/2018	16/08/2018	16/08/2018	21/08/2018	21/08/2018	/	23/08/2018	23/08/2018	23/08/2018	/	/
5	6857	08/06/2018	26/07/2018	07/08/2018	07/08/2018	09/08/2018	14/08/2018	14/08/2018	16/08/2018	16/08/2018	21/08/2018	21/08/2018	/	23/08/2018	23/08/2018	23/08/2018	/	/

2x Anodic bonding  
21/8/18



2x Anodic bonding  
tomorrow